



### 1. General description

High-speed switching diode, encapsulated in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- High switching speed:  $t_{rr} \le 4$  ns
- Low capacitance: C<sub>d</sub> ≤ 2 pF
- Low leakage current
- Reverse voltage: V<sub>R</sub> ≤ 90 V
- Very small SMD plastic packages
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

#### 3. Applications

- High-speed switching
- · General-purpose switching

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Symbol	Falametei	conditions		тур	IVIAX	Unit
Per diode						
I <sub>R</sub>	reverse current	V <sub>R</sub> = 80 V; T <sub>amb</sub> = 25 °C	-	-	0.5	μA
V <sub>R</sub>	reverse voltage		-	-	90	V
t <sub>rr</sub>	reverse recovery time	$I_F$ = 10 mA; $I_R$ = 10 mA; $R_L$ = 100 Ω; $I_{R(meas)}$ = 1 mA; $T_{amb}$ = 25 °C	-	-	4	ns



## 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)		
2	K2	cathode (diode 2)		A1;A2 K4 K3
3	A3; A4	common anode (diode 3 and diode 4)		
4	K3	cathode (diode 3)		
5	K4	cathode (diode 4)		K1 K2 A1;A2
6	A1; A2	common anode (diode 1 and diode 2)	TSSOP6 (SOT363)	006aab102

## 6. Ordering information

#### Table 3. Ordering information

Type number	number Package					
	Name	Description	Version			
BAW56S-Q		plastic, surface-mounted package; 6 leads; 0.65 mm pitch; 2.1 mm x 1.25 mm x 0.95 mm body	SOT363			

### 7. Marking

#### Table 4. Marking codes

Type number	Marking code[1]
BAW56S-Q	A1%

[1] % = placeholder for manufacturing site code

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
Per diode		-				
V <sub>RRM</sub>	repetitive peak reverse voltage			-	90	V
V <sub>R</sub>	reverse voltage			-	90	V
l <sub>F</sub>	forward current	T <sub>s</sub> = 60 °C		-	250	mA
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 1 µs; square wave; $T_{j(init)}$ = 25 °C		-	4	А
		t <sub>p</sub> = 1 ms; square wave; T <sub>j(init)</sub> = 25 °C		-	1	А
		t <sub>p</sub> = 1 s; square wave; T <sub>j(init)</sub> = 25 °C		-	0.5	А
I <sub>FRM</sub>	repetitive peak forward current			-	500	mA
P <sub>tot</sub>	total power dissipation	T <sub>s</sub> = 60 °C	[1]	-	350	mW
Per device						
I <sub>F</sub>	forward current	T <sub>s</sub> = 60 °C		-	100	mA
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-65	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

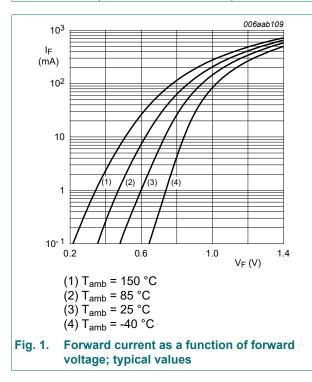
### 9. Thermal characteristics

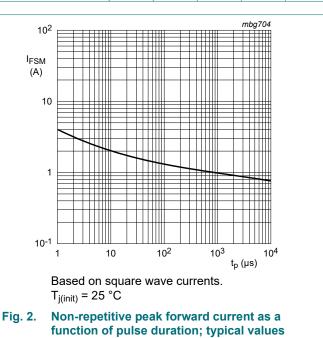
#### Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	255	K/W

## **10. Characteristics**

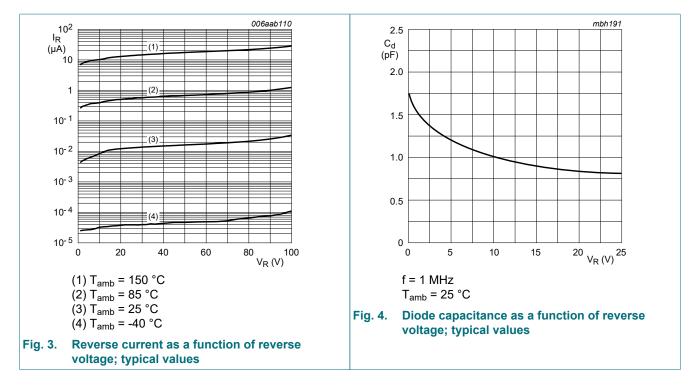
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per diode						
VF	forward voltage	$\label{eq:IF} \begin{array}{l} I_F = 1 \text{ mA; } t_p \leq \ 300 \ \mu s; \ \delta \leq \ 0.02; \\ pulsed;  T_amb = 25 \ ^\circ C \end{array}$	-	-	715	mV
		$\label{eq:IF} \begin{array}{l} I_{F} = 10 \text{ mA; } t_{p} \leq \ 300 \ \mu\text{s}; \ \delta \leq \ 0.02; \\ pulsed;  T_{amb} = 25 \ ^{\circ}\text{C} \end{array}$	-	-	855	mV
		$\label{eq:IF} \begin{array}{l} I_{F} = 50 \text{ mA; } t_{p} \leq \ 300 \ \mu\text{s}; \ \delta \leq \ 0.02; \\ pulsed; \ T_{amb} = 25 \ ^{\circ}\text{C} \end{array}$	-	-	1	V
		I <sub>F</sub> = 150 mA; t <sub>p</sub> ≤ 300 μs; $\delta$ ≤ 0.02; pulsed; T <sub>amb</sub> = 25 °C	-	-	1.25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 25 V; T <sub>amb</sub> = 25 °C	-	-	30	nA
		V <sub>R</sub> = 80 V; T <sub>amb</sub> = 25 °C	-	-	0.5	μA
		V <sub>R</sub> = 25 V; T <sub>j</sub> = 150 °C	-	-	30	μA
		V <sub>R</sub> = 80 V; T <sub>j</sub> = 150 °C	-	-	150	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 0 V; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	-	2	pF
t <sub>rr</sub>	reverse recovery time	$I_F$ = 10 mA; $I_R$ = 10 mA; $R_L$ = 100 Ω; $I_{R(meas)}$ = 1 mA; $T_{amb}$ = 25 °C	-	-	4	ns
V <sub>FRM</sub>	peak forward recovery voltage	$I_F$ = 10 mA; $t_r$ = 20 ns; $T_{amb}$ = 25 °C	-	-	1.75	V



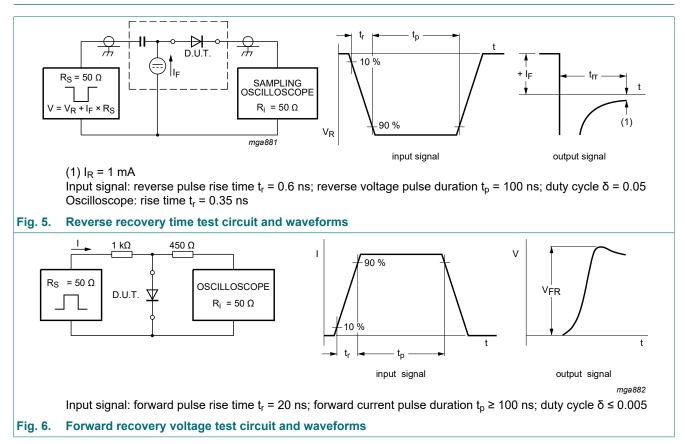


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#### High-speed switching diode



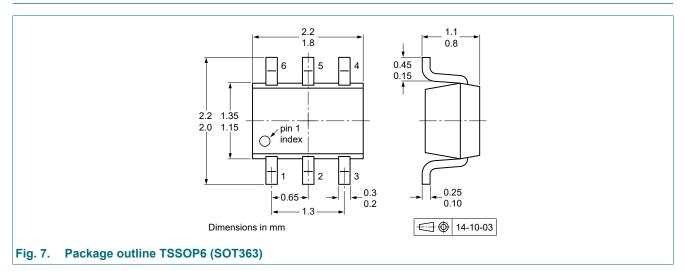
### **11. Test information**



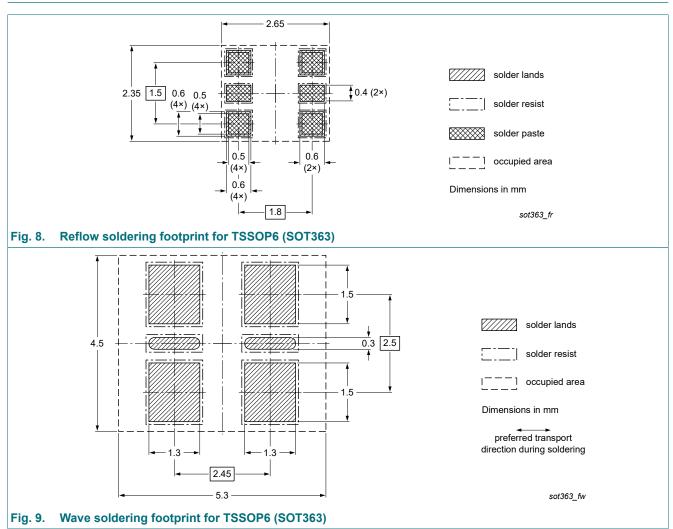
#### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering



**Product data sheet** 

## 14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
BAW56S-Q v.1	20210618	Product data sheet	-	-		

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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#### High-speed switching diode

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**Product data sheet** 

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